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PPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/748,548	12/30/2003	Frank J. Bottari	MTS-185J	9084
32692	7590 09/22/2005		EXAM	INER
3M INNOV	ATIVE PROPERTIES	CHAN, SING P		
	PO BOX 33427 ST. PAUL, MN 55133-3427		ART UNIT	PAPER NUMBER
 ,			1734	

DATE MAILED: 09/22/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)
	10/748,548	BOTTARI ET AL.
Office Action Summary	Examiner	Art Unit
	Sing P. Chan	1734
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet with	the correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING [- Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by staturent and patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICAL 136(a). In no event, however, may a reposit will apply and will expire SIX (6) MONTH te, cause the application to become ABA	ATION. ly be timely filed IS from the mailing date of this communication. NDONED (35 U.S.C. § 133).
Status		
1) Responsive to communication(s) filed on 2a) This action is FINAL. 2b) This action is FINAL. 3) Since this application is in condition for allowed closed in accordance with the practice under	is action is non-final. ance except for formal matter	
Disposition of Claims	, ,	,
4) ☐ Claim(s) <u>1-43</u> is/are pending in the application 4a) Of the above claim(s) <u>15,20-26,35,38,39 as</u> 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) <u>1-14,16-19,27-34,36,37,41 and 43</u> is 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/	and 42 is/are withdrawn from s/are rejected.	consideration.
9) ☐ The specification is objected to by the Examin 10) ☑ The drawing(s) filed on 30 December 2003 is/ Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the E	are: a)⊠ accepted or b)□ or e drawing(s) be held in abeyance ction is required if the drawing(s	e. See 37 CFR 1.85(a). is objected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document * See the attached detailed Office action for a list 	nts have been received. Its have been received in Apporting documents have been received in the contract of th	olication No eceived in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 2/17/04.		Mail Date Immal Patent Application (PTO-152)

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DETAILED ACTION

Election/Restrictions

1. Applicant's election with traverse of Group I, claims 1-14, 16-19, 27-34, 36, 37, 41, and 43 in the reply filed on June 29, 2005 is acknowledged. Applicant traverses the restriction requirement but did not provide any ground or reason for traversing the requirement and therefore the requirement is deemed proper and is made FINAL. Also, claim 40 was mistakenly left off the restriction requirement and should have been placed into group III, which is non-elected and withdrawn from consideration.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1, 2, 5-9, 11, 13, 14, 16, 18, 27-31, 33, 36, 37 and 41 are rejected under 35 U.S.C. 103(a) as being unpatentable over Bottari (U.S. 6,280,552) in view of Levesoue et al (U.S. 3, 703, 603) and Hoyt (U.S. 2,711,983).

Regarding claims 1, 2, 5-9, 16, 18, 27, 26, 27-31, and 41, Bottari discloses a method of applying an edge electrode pattern to a touch screen. The method includes providing a strip of decal paper, applying a conductive material in an edge electrode pattern on the decal paper (Col 5, lines 33-35), applying an isolation layer on the edge electrode pattern (Col 6, lines 24-26), applying a conductive material in a conductive land or lead, i.e. wire trace, pattern on the isolation layer in an adjacent relation to the

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edge electrode pattern (Col 6, lines 27-30), applying a protective layer over the wire trace pattern (Col 6, lines 3-34), removing the decal paper (Col 6, line 35), applying the decal with the edge electrode pattern, isolation layer, wire trace, and protective layer onto a touch screen with the edge electrode closest to the surface of the touch screen (Col 6, lines 36—37), and heating the touch screen and the applied decal to bond the decal to the touch screen (Col 6, lines 5-10). Bottari is silent as to the decal is a heat transfer decal. However, applying printed circuit pattern with a heat transfer decal is well known and conventional as shown for example by Levesoue et al. Levesoue et al. discloses a method of transferring electric circuit pattern. The method includes providing a decal paper (50, 52) (Col 4, lines 39-46), applying an insulation layer 60 onto the decal paper (Col 4, lines 61-65), applying an adhesive layer, which is a conductive material (Col 4, lines 13-28), to the insulation layer (Col 4, lines 65-67), applying the decal to the circuit board substrate (Col 4, lines 49-51), applying pressure and friction by rubbing the carrier (50), which generate heat, to melt the release agent (52) to bond the circuit pattern to the circuit board (Col 4, lines 51-58), and then removing the carrier 50 (Col 4, lines 59-60).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to apply the circuit pattern with a heat transfer decal as disclosed by Levesoue et al in the method of Bottari as motivated by fact that Hoyt, also discloses a method of forming decals with printed conductive patterns, which are transferable to a circuit substrate by using either "press-on" or "slide-off" decals (Col 2, lines 5-30), which are all equivalents and functional expedients well known within the art.

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Regarding claims 11 and 33, Bottari discloses the conductive material (Col 5, lines 33-35) and wire trace pattern (Col 6, lines 53-55) are applied by screen printing.

Regarding claims 13 and 14, Bottari discloses the isolation layer is lead borosilicate glass material. (Col 6, lines 24-27)

4. Claims 10, 12, 17, 19, 32, and 34 are rejected under 35 U.S.C. 103(a) as being unpatentable over Bottari (U.S. 6,280,552) in view of Levesoue et al (U.S. 3, 703, 603) and Hoyt (U.S. 2,711,983) as applied to claims 1, 16, 18, and 27 above, and further in view of Kikuchi (U.S. 5,600,359).

Regarding claims 10, 17, 19, and 32, Bottari as modified above is silent as to applying the pattern with hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate or touch screen. However, applying a pattern on a carrier foil using a hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate is well known and conventional as shown for example by Kikuchi. Kikuchi discloses a hot stamping machine equipped with a heated pad (40) (Col 6, lines 12-29) disposed between a feed roll of transfer film (71) and take-up roll (72) (Col 7, lines 41-55) and over a holder (60) for a substrate (5) (Col 5, lines 46-51) to transfer portions (12, 13, and 14) of the transfer film (10) (Figures 2-5).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to provide hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate as disclosed by Kikuchi in the method of Bottari as modified by the

combination of references to provide a method of transfer printing to substrate such as metal or ceramic in a short time in a satisfactory printing state. (See Kikuchi, Col 3, lines 6-13)

Regarding claims 13 and 34, Bottari as modified above silent as to the temperatures and pressure for applying the pattern. However, one of ordinary skill in the art would appreciate the temperatures and pressure ranges would be obtain by routine experimentation and generally, the differences in the temperatures and pressure ranges will not support the patentability of the subject matter encompassed by the prior art unless there is evidence indicating such ranges is critical. See In re Aller, 220 F.2d 454, 456, 105 USPQ 233, 235 (CCPA 1955)

It would have been obvious to one of ordinary skill in the art at the time the invention was made to provide any temperatures and pressure range, which are the optimum in the method of Bottari motivated by the normal desire of scientists or artisans to improve upon what is already generally known to disclose a set of optimum ranges.

5. Claim 43 is rejected under 35 U.S.C. 103(a) as being unpatentable over Bottari (U.S. 6,280,552) in view of Levesoue et al (U.S. 3, 703, 603), Hoyt (U.S. 2,711,983), and Kikuchi (U.S. 5,600,359).

Bottari discloses a method of applying an edge electrode pattern to a touch screen. The method includes providing a strip of decal paper, applying a conductive material in an edge electrode pattern on the decal paper (Col 5, lines 33-35), applying an isolation layer on the edge electrode pattern (Col 6, lines 24-26), applying a conductive material in a conductive land or lead, i.e. wire trace, pattern on the isolation

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layer in an adjacent relation to the edge electrode pattern (Col 6, lines 27-30), applying a protective layer over the wire trace pattern (Col 6, lines 3-34), removing the decal paper (Col 6, line 35), applying the decal with the edge electrode pattern, isolation layer, wire trace, and protective layer onto a touch screen with the edge electrode closest to the surface of the touch screen (Col 6, lines 36—37), and heating the touch screen and the applied decal to bond the decal to the touch screen (Col 6, lines 5-10). Bottari is silent as to the decal is a heat transfer decal and applying the pattern with hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate or touch screen. However, applying printed circuit pattern with a heat transfer decal is well known and conventional as shown for example by Levesoue et al. Levesoue et al discloses a method of transferring electric circuit pattern. The method includes providing a decal paper (50, 52) (Col 4, lines 39-46), applying an insulation layer 60 onto the decal paper (Col 4, lines 61-65), applying an adhesive layer, which is a conductive material (Col 4, lines 13-28), to the insulation layer (Col 4, lines 65-67), applying the decal to the circuit board substrate (Col 4, lines 49-51), applying pressure and friction by rubbing the carrier (50), which generate heat, to melt the release agent (52) to bond the circuit pattern to the circuit board (Col 4, lines 51-58), and then removing the carrier 50 (Col 4, lines 59-60).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to apply the circuit pattern with a heat transfer decal as disclosed by Levesoue et al in the method of Bottari as motivated by fact that Hoyt, also discloses a method of forming decals with printed conductive patterns, which are transferable to a

circuit substrate by using either "press-on" or "slide-off" decals (Col 2, lines 5-30), which are all equivalents and functional expedients well known within the art. Bottari as modified by combination of references is silent as to applying the pattern with hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate or touch screen. However, applying a pattern on a carrier foil using a hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate is well known and conventional as shown for example by Kikuchi. Kikuchi discloses a hot stamping machine equipped with a heated pad (40) (Col 6, lines 12-29) disposed between a feed roll of transfer film (71) and take-up roll (72) (Col 7, lines 41-55) and over a holder (60) for a substrate (5) (Col 5, lines 46-51) to transfer portions (12, 13, and 14) of the transfer film (10) (Figures 2-5).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to provide hot stamp machine equipped with a heated pad disposed between a feed roll of decal paper and take-up roll and over a hold for the substrate as disclosed by Kikuchi in the method of Bottari as modified by the combination of references to provide a method of transfer printing to substrate such as metal or ceramic in a short time in a satisfactory printing state. (See Kikuchi, Col 3, lines 6-13)

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Allowable Subject Matter

6. Claims 3 and 4 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

7. The following is a statement of reasons for the indication of allowable subject matter: None of the prior art of record discloses applying an edge electrode pattern and a wire trace pattern and isolating them from each other after they have been transferred to the touch screen using a laser.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Sing P. Chan whose telephone number is 571-272-1225. The examiner can normally be reached on Monday-Thursday 7:30AM-11:00AM and 12:00PM-4:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Christopher A. Fiorilla can be reached on 571-272-1187. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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SPC

CHRIS FIORILLA
SUPERVISORY PATENT EXAMINER

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